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- EPIC ™ (Enhanced-Performance Implanted **CMOS) Submicron Process**
- Output Ports Have Equivalent 26- $\Omega$  Series Resistors, So No External Resistors Are Required
- Typical V<sub>OLP</sub> (Output Ground Bounce) < 0.8 V at  $V_{CC} = 3.3 \text{ V}, T_A = 25^{\circ}\text{C}$
- Typical V<sub>OHV</sub> (Output V<sub>OH</sub> Undershoot)  $> 2 \text{ V at V}_{CC} = 3.3 \text{ V, T}_{A} = 25^{\circ}\text{C}$
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V<sub>CC</sub>)
- ESD Protection Exceeds 2000 V Per MIL-STD-883C, Method 3015; Exceeds 200 V Using Machine Model (C = 200 pF, R = 0)
- Latch-Up Performance Exceeds 250 mA Per JEDEC Standard JESD-17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), and Thin Shrink Small-Outline (PW) **Packages**

#### DB, DW, OR PW PACKAGE (TOP VIEW)

10E [	1	U	20	] v <sub>cc</sub>
1A1 [			19	] 20E
2Y4 [				] 1Y1
1A2 [	4			2A4
2Y3 [				] 1Y2
1A3 [	6		15	2A3
2Y2 [				] 1Y3
1A4 [				] 2A2
2Y1 [	9		12	] 1Y4
GND [	10		11	] 2A1

#### description

This octal buffer/line driver is designed for 2.7-V to 3.6-V V<sub>CC</sub> operation; it can interface to a 5-V system environment.

The SN74LVC2244 is organized as two 4-bit line drivers with separate output-enable ( $\overline{OE}$ ) inputs. When  $\overline{OE}$ is low, the device passes data from the A inputs to the Y outputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

The outputs, which are designed to sink up to 12 mA, include 26-Ω resistors to reduce overshoot and undershoot.

To ensure the high-impedance state during power up or power down,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74LVC2244 is characterized for operation from -40°C to 85°C.

#### **FUNCTION TABLE** (each buffer)

INPUTS		OUTPUT
ŌĒ	Α	Y
L	Н	Н
L	L	L
_н	Х	Z



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

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STRUMENTS

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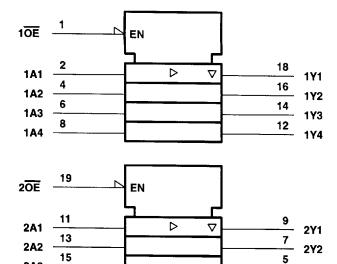
PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas instruments standard warranty. Production processing does not necessarily include testing of all parameters.

#### logic symbol†

2A3

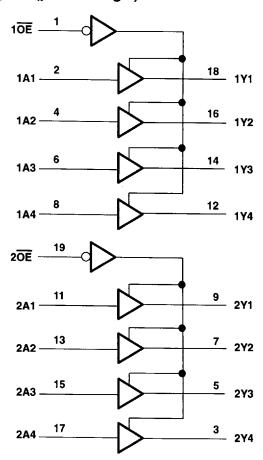
2A4

17



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

### logic diagram (positive logic)



# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

**2Y3** 

**2Y4** 

3

Supply voltage range, Voc	- 4 0 1/
Supply voltage range, V <sub>CC</sub> –0.5 V to	5 4.6 V
Input voltage range, V <sub>I</sub> (see Note 1)	o 6.5 V
Voltage range applied to any output in the high-impedance state, $V_O$ (see Note 1) $-0.5$ V to	o 6.5 V
Voltage range applied to any output in the high	
or low state, V <sub>O</sub> (see Notes 1 and 2)	- 0.5 V
Input clamp current, $I_{ K }(V_1 < 0)$	50 m A
Output along around 1 (V)	SU IIIA
Output clamp current, I <sub>OK</sub> (V <sub>O</sub> < 0) ±	50 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ ) $\pm$	50 mA
Continuous current through V <sub>CC</sub> or GND+1	00 mA
Maximum power dissipation at T <sub>A</sub> = 55°C (in still air) (see Note 3): DB package	0.6 W
DW package	
PW package	0.7 W
Storage temperature range, T <sub>stq</sub> 65°C to	150°C

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.

- 2. This value is limited to 4.6 V maximum.
- 3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.



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### recommended operating conditions (see Note 4)

			MIN	MAX	UNIT	
Vcc	Supply voltage	Operating	2	3.6	.,	
		Data retention only	1.5		V	
٧ <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V	2		٧	
$V_{IL}$	Low-level input voltage	V <sub>CC</sub> = 2.7 V to 3.6 V		0.8	٧	
٧ <sub>I</sub>	Input voltage		0	5.5	٧	
٧o	Output voltage	High or low state	0	Vcc		
		3 state	0	5.5	V	
ЮН	High-level output current	V <sub>CC</sub> = 2.7 V		-8		
.Оп		V <sub>CC</sub> = 3 V		-12	mA	
<sup>l</sup> OL	Low-level output current	V <sub>CC</sub> = 2.7 V		8		
	cow-level output current	V <sub>CC</sub> = 3 V		12	mA	
Δt/Δν	Input transition rise or fall rate		0	10	ns/V	
TA	Operating free-air temperature			85	°C	

NOTE 4: Unused inputs must be held high or low to prevent them from floating.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub> †	MIN TYP# MAX	UNIT		
	I <sub>OH</sub> = -100 μA	MIN to MAX	V <sub>CC</sub> -0.2	1		
	$I_{OH} = -4 \text{ mA}$	2.7 V	2.2	1		
Voн	IOH = -8  mA	2.7 V	2	V		
	$I_{OH} = -6 \text{ mA}$	3 V	2.4	1		
	I <sub>OH</sub> = - 12 mA	3 V	2	1		
ļ	I <sub>OL</sub> = 100 μA	MIN to MAX	0.2			
1	I <sub>OL</sub> = 4 mA	2.7 V	0.4	1		
V <sub>OL</sub>	IOL = 8 mA	2.7 V	0.6	5 V		
	IOL = 6 mA	3 V	0.55			
	I <sub>OL</sub> = 12 mA	3 V	0.8			
lı lı	$V_{\parallel} = 5.5 \text{ V or GND}$	3.6 V	±5	μΑ		
loz	$V_O = 5.5 \text{ V or GND}$	3.6 V	±10	10 µA		
102	V <sub>O</sub> = 3.6 V or 5.5 V	MIN to MAX	±50			
lcc lcc	$V_1 = V_{CC}$ or GND, $I_0 = 0$	3.6 V	10	μА		
ΔlCC	One input at $V_{CC} = 0.6 \text{ V}$ , Other inputs at $V_{CC}$ or GND	2.7 V to 3.6 V	500	μА		
Ci	V <sub>I</sub> = V <sub>CC</sub> or GND	3.3 V	3.1	pF		
Co	V <sub>O</sub> = V <sub>CC</sub> or GND	3.3 V	5	pF		

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.



 $<sup>\</sup>ddagger$  All typical values are measured at V<sub>CC</sub> = 3.3 V, T<sub>A</sub> = 25°C.

## SN74LVC2244 OCTAL BUFFER/DRIVER WITH 3-STATE OUTPUTS

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# switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

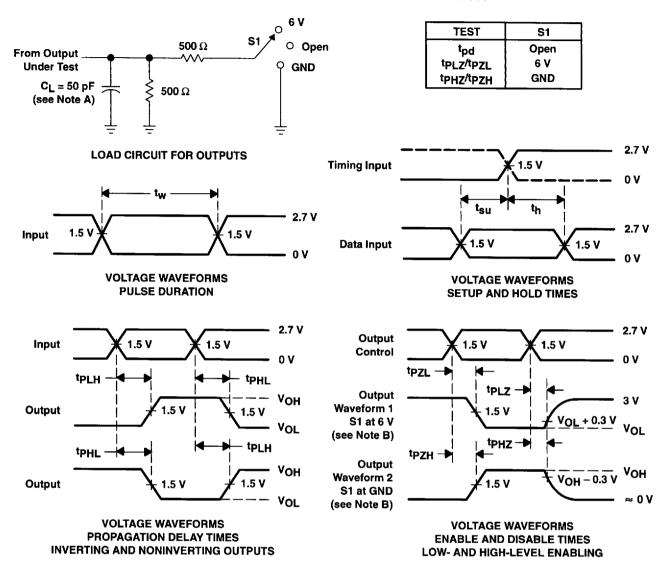
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V <sub>CC</sub> =	V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V	
			MIN	MAX	MIN	MAX	UNIT
t <sub>pd</sub>	A	Υ	1.5	7.5		8.5	ns
t <sub>en</sub>	ŌĒ	Υ	1.5	9		10	ns
<sup>t</sup> dis	ŌĒ	Υ	1.5	7		8	ns
t <sub>sk(o)</sub> †	<del></del>			1			ns

<sup>†</sup> Skew between any two outputs of the same package switching in the same direction. This parameter is warranted but not production tested.

# operating characteristics, $V_{CC}$ = 3.3 V, $T_A$ = 25°C

PARAMETER			TEST CONDITIONS	TYP	UNIT
Cnd	Power dissipation capacitance per buffer/driver	Outputs enabled	C. 50 = 5 40 MHz	30	
<sup>C</sup> pd		Outputs disabled	$C_L = 50 \text{ pF}, f = 10 \text{ MHz}$	2	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ ,  $t_f \leq$  2.5 ns,  $t_f \leq$  2.5 ns.
- D. The outputs are measured one at a time with one transition per measurement.
- E. tpLZ and tpHZ are the same as tdis.
- F. tpzL and tpzH are the same as ten.
- G. tplH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms

